



Fabrication and Reliability Characterizations of GaN-HEMT Devices for Power Applications



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Current status/stage of your JDP: Comprehensive completed, total 4 years completed, .

• Research Key Area

1. Enhancement of device statistics through refinements in the fabrication process.
2. Reliability characterization of FEG-HEMT device for power application
3. Investigation of the degradation mechanism by using the reliability characterization.
4. Development of the more advanced performance HEMTs devices by utilization of the quaternary InAlGaN barrier layer and their reliability characterization.
5. Conducting reliability assessments on well-established industry GaN-HEMTs devices.

• Significant Achievements

Journal Publication: IEEE-Transaction on Electron Device

Conference publication: IEEE-LAEDC

